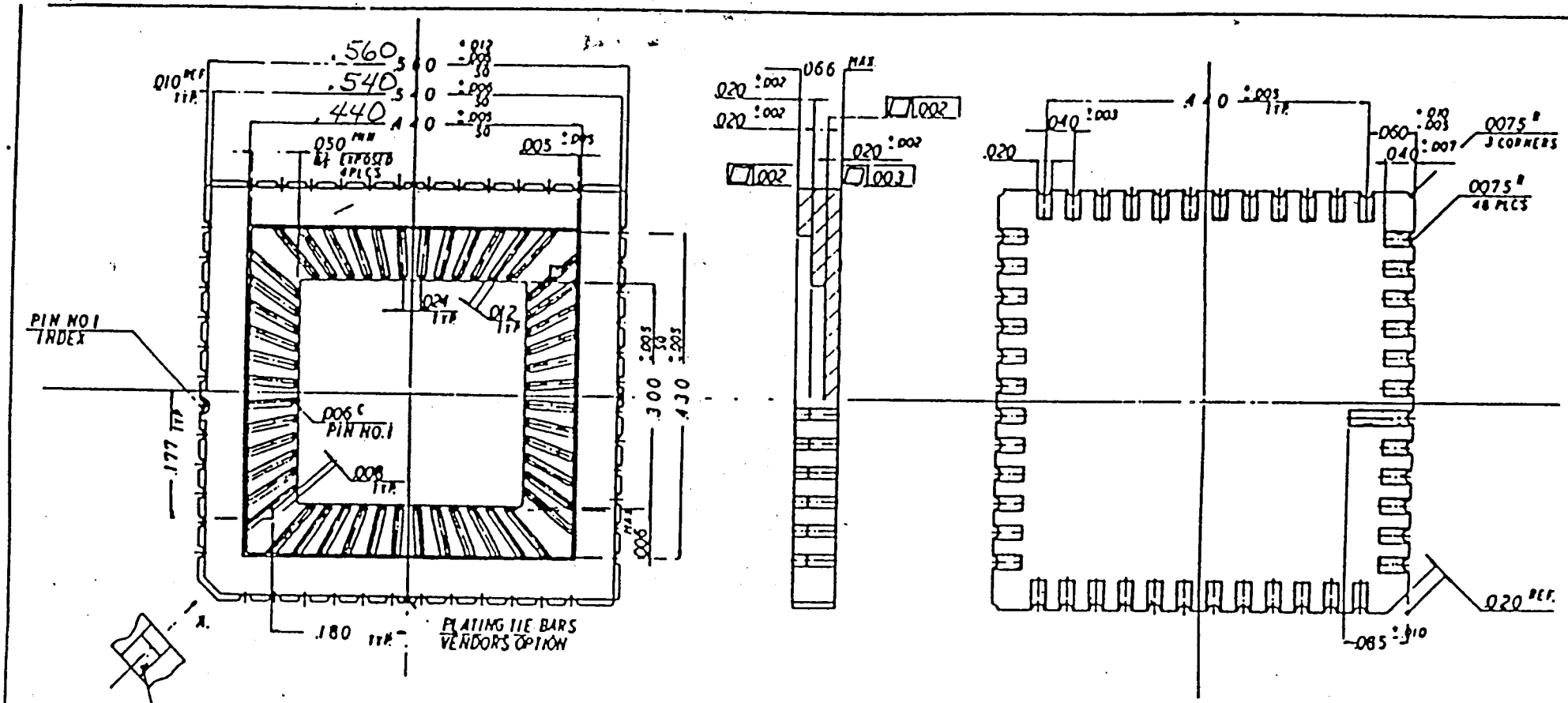

NOTES

1 ALL EXPOSED METALLIZED AREA SHALL BE GOLD PLATED 60 MICRO INCHES MIN THK OVER NICKEL PLATING. UNLESS OTHERWISE SPECIFIED IN PURCHASE ORDER.

2 FLATNESS PERTAINS METALLIZED PAD ONLY.

3 SEAL AREA AND DIE ATTACH AREA SHALL BE ISOLATED FROM ANY LEADS (ZERO GROUND)

LCC04801

NAME 48 LEAD CHIP CARRIER			
DATE 10/1	MATERIAL KYOCERA A-440	±1 ± NL.T ±.005	
CHANGE			

KYOTO CERAMIC CO., LTD. JAPAN

PB-13266

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81-12-8